



PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

April 29, 2009

Applicants: Masashi KUMAGAI et al

For: COPPER ELECTROLYTIC SOLUTION AND
ELECTROLYTIC COPPER FOIL PRODUCED THEREWITH

Serial No.: 10/531 645

Group: 1795

Confirmation No.: 1483

Filed: April 15, 2005

Examiner: Mendez

International Application No.: PCT/JP2003/013044

International Filing Date: October 10, 2003

Atty. Docket No.: 4700.P0312US

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE

Sir:

In response to the Office Action dated January 29, 2009,
please amend the above-identified application as follows:

(Please see following pages.)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being
deposited with the United States Postal Service with
sufficient postage as first class mail in an envelope
addressed to: Commissioner for Patents, P.O. Box 1450,
Alexandria, VA 22313-1450, on April 29, 2009.


Terryence F. Chapman